

Lenovo P14s i Gen 6

Version: 1.0 | 10/16/2025

Product Name	P14s i Gen 6
Product Display Name	P14s i Gen 6
Information Date	Sep 4 2025

SECTION I: Platform Overview

Description		Designed for highly mobile power users, the Lenovo ThinkPad P14s i is a compact, ultra-lightweight workstation, ideal for students, architects, and engineers to be creative anytime, anywhere.
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CPU

Processor Support		Arrow Lake H Processor Ultra5/7/9
Socket Type		BGA
Disclaimers		
Operating Systems		

Preloaded		Windows 11 Pro 64 (Win11 24H2) Windows 11 Home 64 Windows 11 Home Chinese Language Edition 64 Ubuntu (v24.04)
Supported		Windows 11 Pro 64 (Win11 24H2) Windows 11 Home 64 Windows 11 Home Chinese Language Edition 64 Ubuntu (v24.04)
Disclaimers		

Memory

Number of DIMM Slots		2 slots
Channels		Single channel with 1x SODIMM/CSoDIMM , Dual channel with 2x SODIMM/CSoDIMM
Type		DDR5
ECC Support		No
Speed		SoDIMM 5600 MT/s or CSoDIMM 6400MT/s
Max DIMM Size		48GB
Max System Memory		96GB
Min System Memory		16GB
Soldered Memory		NO
Disclaimers		

Storage

Storage Slots		1 x PCIe Gen 4 M.2 2280
SATA		/
PCIe		Solid State Drive, OPAL2 PCIe-NVMe Gen 4 M.2 2280- TLC

SAS		None
Interface		PCIe Gen 4
Security		PCIE
Optional Hard Disk Drive Controllers		OPAL2 for NVMe SSD
Disclaimers		

Video

Integrated Graphics		Intel Arc Pro Integrated Graphics (with at least 16GB dual dimm populated) Integrated Graphics (single DIMM or <16GB dual dimm)
Discrete Graphics		NNVIDIA RTX PRO 1000 (8GB GDDR7) / 500 (6GB GDDR7)Blackwell Generation Laptop GPU
Adapter		None
Bus Interface		PEG
Disclaimers		

Display

Resolutions		WUXGA / 2.5k /3k
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Camera

Resolution		5M
Frames per Second		30 fps
Focus		FF 50cm(fixed focus)
Camera Interface		USB 2.0
IR Camera		Yes (optional)

Keyboard

Number of Keys		US : 84 / UK : 85 / JP : 89
Numpad		No
Size		100% ISO
Function Key Features		Yes
Backlit		Yes
Keyboard size		CS24 full size KBD
Key stroke		1.5mm
Key pitch		19.05mm
Keyboard backlight		Yes
Keyboard thickness		4.0mm

Touchpad / Fingerprint Reader

TrackPoint Details		TrackPoint module (t4.8mm)
Finger Print Reader Model		Normal MoC Round FoP, Black
Multi-Touch		Yes
Resolution		1000 ppi
TouchPad/Trackpad thickness		3.4mm
TouchPad/Trackpad type		3 BCP
Trackpad size		115mm x 60mm
Trackpad material/finish		Glass like mylar surface

I/O – Ports and Connectors

USB		2x USB-A 3.2 (Gen 1) (1 powered)
Thunderbolt		2x Thunderbolt 4 (USB 4/USB-C 3.2 Gen

		2/DP2.1/PD)
HDMI		1x HDMI 2.1 TMDS up to 4K/60Hz
Audio Combo Jack		1x Microphone & Headphone Combo Jack (3.5mm)
Media Card Reader		N/A
Smart Card Reader		Yes (optional)
Power Connector		DC-In
Docking Port		Docking Via Thunderbolt 4
VirtualLink		None
Network adapter		Gigabit Ethernet (RJ45)
Disclaimers		

Power Connector

Main		DC-In
USB-C		1x Thunderbolt 4 (USB-C/DP/PD)
Disclaimers		

Ethernet

Vendor		Intel
Count		x1
EEPROM		SPI ROM (Merge with BIOS/MEFW)
Speeds		10/100/1000 Mbps
Functions		Wake On LAN MAC Address Pass Through PXE Boot Flash Over LAN
Connectors		Drop-jaw RJ45

Disclaimers		
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WWAN

Model		NA
Disclaimers		

Near Field Communications

Model		NA
Disclaimers		

Audio

Vendor		Realtek
Type		High Definition Audio Codec
Internal Speaker		Yes, dual speakers
Connectors		Microphone & Headphone Combo Jack (3.5mm)
Chipset		ALC3287
Number of Channels		4-channel DAC, 4-channel ADC
Number of Bits/Audio Resolution		16/20/24-bit PCM format
Sampling Rate (Recording/Playback)		48000Hz
Signal to Noise Ratio		90dB Signal-to-Noise Ratio (A-weighting) for ADC input. 100dB Signal-to-Noise Ratio (A-weighting) for DAC output
Analog Audio		None
Dolby Digital		Dolby Atmos

Digital Out (S/PDIF)		No
Speaker Power Rating		2W@4ohm/ch
Disclaimers		

Power adapter

Type		100W AC Adapter
Dimensions		108mm x 56mm x 26.5mm
Input Voltage		100-240V
Disclaimers		

Security

TPM		Yes, TPM2.0
Asset ID		Yes
vPro		Yes on vPro model
Disclaimers		

Chassis Information

Format		Ultralim Notebook
Color		Deep Black
Thermal Solutions		Internal dual FAN, Intelligent Cooling
Dimensions		Length 12.81 inches 325.50 millimeters Width 8.96 inches 227.60 millimeters Height Front 11.2 millimeters /0.44 inches

		Rear 15.1 millimeters/0.59 inches
Weight		Starting weight UMA 1.60kg / 3.53lbs SWC 1.64kg / 3.61lbs
Disclaimers		

Packaging Parameters

Height (mm)		296
Height (inch)		11.7
Width (mm)		477
Width (inch)		18.8
Depth (mm)		79
Depth (inch)		3.1
Weight (kgs)		0.52
Weight (lbs)		1.15
Disclaimers		

Security & Serviceability

Hardware Maintenance Manual		Yes
Drivers & Software		Yes
Self Healing BIOS		Yes(FW Resilience 2.0)
Access Panel		Removeable bottom cover
Number of Screws		6
Swappable Components		Base cover assembly, TrackPoint pointing stick, Lenovo factory recovery USB key, Power cord, ac power adapter (65W)
Storage Slots		1 storage slot
Memory		2 slots

System Board		1190 System Board. No self-service CRU.
Restore CD/DVD/USB Set		None. Purchase via Lenovo Customer Support Center
Cable Lock Support		Security-lock slot
Power-On Password		Yes
Hard Disk Password		Yes; User and Master hard disk password
Supervisor Password		Yes
NIC LEDs (integrated)		No (if it means the LED for Ethernet)
Security Chip		Yes (for TMP 2.0)
Access Panel Key Lock		Bottom Cover Tamper Detection
Boot Sequence Control		Yes
Disclaimers		

Operating Environment

Operating – Air Temperature		At altitudes up to 2438 m (8000 ft) – Operating: 5°C to 35°C (41°F to 95°F)
Non Operating – Air Temperature		At altitudes up to 2438 m (8000 ft) – Storage: 5°C to 43°C (41°F to 109°F)
Humidity		Operating: 8% to 95% at wet-bulb temperature 23°C (73°F) Storage: 5% to 95% at wet-bulb temperature 27°C (81°F)
Corrosive Gas		G1
Particulates		P1
Disclaimers		

SECTION II: Platform Detail

Supported Components

Processor		Ultra 5 -225H Non-vPro Ultra 5 235H vPro Ultra 7 255H non-vPro Ultra 7 265H vPro Ultra 9 285H vPro
Memory Support		DDR5
Chipset (PCH)		Integrated Soc
Size of BIOS Flash		64M + 16M
Super I/O		N/A
Clock		Crystal
Audio		Realtek High Definition Audio
Ethernet		Non-vPro model: Intel® Ethernet Connection I219-V (Jacksonville) vPro model: Intel® Ethernet Connection I219-LM (Jacksonville)
Notes		
Disclaimers		

Memory

System Capacity Options		Upto 96GB
non-ECC		Yes
Brand of non-ECC Memory		Samsung/Ramaxel/Hynix/Micron(Micron ROW only)
ECC		None
Brand of ECC Memory		N/A

Memory clock frequency(MHz)		SoDIMM 5600 MT/s or CSoDIMM 6400MT/s
Disclaimers		

Storage

2.5" SAS Hard Disk Drive (HDD)		None
2.5" SATA Hard Disk Drive (HDD)		None
2.5" SATA Solid State Drive (SSD)		None
M.2 (NGFF) PCIe Solid State Drive (SSD)		256GB Opal 2 PCIe G4 NVMe M.2 2280 512GB Opal 2 PCIe G4 NVMe M.2 2280 512GB Opal 2 PCIe G5 NVMe Performance M.2 2280 1TB Opal 2 PCIe G4 NVMe M.2 2280 1TB Opal 2 PCIe G5 NVMe Performance M.2 2280 2TB Opal 2 PCIe Gen5 Performance NVMe M.2 2280
2.5" PCIe Solid State Drive (SSD)		None
Brand of Drive		Samsung Kioxia UnionMem Hynix Micron SanDisk WD
Intel Optane Storage Technology		Yes
RAID		Not Supported
RAID Level and Requirements		
Disclaimers		

Removeable Media

Media Card Reader Specifications		N/A
Disclaimers		

SECTION III: Supported Component Detail				
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CPU Specifications

CPU		Ultra 5 -225H Non-vPro	Ultra 5 235H vPro	Ultra 7 255H non-vPro	Ultra 7 265H vPro	Ultra 9 285H vPro
Integrated Graphics		Intel Arc Pro Integrated Graphics (with at least 16GB dual dimm populated) Integrated Graphics (single DIMM or <16GB dual dimm)	Intel Arc Pro Integrated Graphics (with at least 16GB dual dimm populated) Integrated Graphics (single DIMM or <16GB dual dimm)	Intel Arc Pro Integrated Graphics (with at least 16GB dual dimm populated) Integrated Graphics (single DIMM or <16GB dual dimm)	Intel Arc Pro Integrated Graphics (with at least 16GB dual dimm populated) Integrated Graphics (single DIMM or <16GB dual dimm)	Intel Arc Pro Integrated Graphics (with at least 16GB dual dimm populated) Integrated Graphics (single DIMM or <16GB dual dimm)
# of Cores		14	14	16	16	16
# of Threads		14	14	16	16	16
Max Turbo Frequency		4.9 GHz	5 GHz	5.1 GHz	5.3 GHz	5.4 GHz
P-core Max Turbo Frequency		4.9 GHz	5 GHz	5.1 GHz	5.2 GHz	5.4 GHz
E-core Max Turbo Frequency		4.3 GHz	4.4 GHz	4.4 GHz	4.6 GHz	4.5 GHz
Cache		18MB	18MB	24 MB	30 MB	24 MB
TDP		20W-65W	20W-65W	20W-65W	20W-65W	35W-65W
Intel ARK Spec Link		https://www.intel.com/content/www/us/en/products/sku/241749/intel-core-ultra-5-processor-225h-18m-cache-up-to-4-90-ghz/specifications.html	https://www.intel.com/content/www/us/en/products/sku/241748/intel-core-ultra-5-processor-235h-18m-cache-up-to-5-00-ghz/specifications.html	https://www.intel.com/content/www/us/en/products/sku/241751/intel-core-ultra-7-processor-255h-24m-cache-up-to-5-10-ghz/specifications.html	https://www.intel.com/content/www/us/en/products/sku/241068/intel-core-ultra-7-processor-265-30m-cache-up-to-5-30-ghz/specifications.html	https://www.intel.com/content/www/us/en/products/sku/241747/intel-core-ultra-9-processor-285h-24m-cache-up-to-5-40-ghz/specifications.html
Disclaimers						

Display Specifications

Model		14.5" 16:10 WUXGA(1920*1200) IPS Anti Glare 400nits,NTSC 45%, 60Hz 3.0T, Non Touch	14.5" 16:10 WUXGA(1920*1200) IPS 400nit 45% NTSC, 60Hz 3.0t,Flat, TÜV Eyesafe,LBL,AG AOFT	14.5" 16:10 3K(3072*1920) IPS Anti Glare 500nits, 100% DCI-P3, 120Hz 2.4T,Non Touch	14.5" 16:10 WQXGA IPS Anti Glare 400nits, 100% sRGB, 90hz 2.4T, AOFT
Resolution		1920 x 1200	1920 x 1200	3072*1920	2560 x 1600
Diagonal		14.5"	14.5"	14.5"	14.5"
Aspect Ratio		Ratio 16:10	Ratio 16:10	Ratio 16:10	Ratio 16:10
Backlight		LED	LED	LED	LED
PPI		156	250	208	
Active Area		312.192 x 195.12	312.192 x 195.12	312.146 x 195.09	312.12 x 195.07
Refresh Rate		60 Hz	60 Hz	120Hz	90 Hz
Contrast Ratio		1200: 1	1200: 1	1500:1 (TYP)	1500:1 (TYP)
Viewing Angle		89/89/89/89 Degree	89/89/89/89 Degree	89/89/89/89 Degree	89/89/89/89 Degree
Color gamut		45% NTSC	45% NTSC	100% DCI-P3	100% sRGB
Brightness		400nit	400nit	500nit	400nit
Contrast		N/A	N/A	N/A	N/A
Color Depth		8bit	8bit	8bit+2FRC	8bit+2FRC
Interface		eDP 1.2	eDP 1.2	eDP 1.4	eDP 1.4
Panel ID Recognition		EDID in BIOS Table	EDID in BIOS Table	EDID in BIOS Table	EDID in BIOS Table
Weight		320g Max	325g Max	245g Max	240g Max
Color Calibrator		AICCP	AICCP	TCON Color Calibration ΔE average <1	X-Rite Pantone Factory Color Calibration
Panel Technology		IPS, Anti-Glare,TUV	IPS, Anti-Glare,TUV	IPS, Anti-Glare,TUV	IPS, Anti-Glare,TUV
Touch Panel		None	AOFT	None	None
Disclaimers					

HDD Specifications

2.5" SAS Hard Disk Drive (HDD)		N/A
2.5" SATA Hard Disk Drive (HDD)		N/A
Disclaimers		

HDD Storage Device Specifications

Connector		N/A
Transfer Rate (Gb/sec)		N/A
Disclaimers		

HDD Performance

Spindle Speed(RPM)		N/A
Power off to Spindle Stop(sec)		N/A
DC Power to Drive Ready(sec)		N/A
Receipt of Start Unit Command to Drive Ready(sec)	N/A	
Average Latency(msec)		N/A
Disclaimers		

HDD Power Management

Input (VDC)		N/A
Typical (Watts)		N/A
Idle (Watts)		N/A
Disclaimers		

HDD Dimensions

Height (mm – Max)		N/A
Width (mm)		N/A
Depth (mm – Max)		N/A
Weight (grams)		N/A
Disclaimers		

HDD Temperature

Operating(C) Ambient		N/A
Operating(C) Base Casting		N/A
Non-Operating(C) Ambient		N/A
Gradient(C per Hour)		N/A
Disclaimers		

HDD Shock

Operating(Gs @ 2ms)		N/A
Non-Operating(Gs @ 2ms)		N/A
Disclaimers		

SSD Specifications

2.5" SATA Solid State Drive (SSD)		N/A
M.2 (NGFF) PCIe Solid State Drive (SSD)		1x M.2 2280 PCIe Gen4
2.5" PCIe Solid State Drive (SSD)		N/A
Intel Optane Storage Technology		N/A

Disclaimers		
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Solid State Storage Devices

Supported Types		M.2
Dimensions inches/centimeters (W x D x H)		22.0 (+-0.15) x 80.0 (+-0.15) x 2.3 (max)
Size		M.2 2280S3
Interface Type		PCIe NVMe Gen4
Read/Write IOPS Specifications		Performance PCIe Gen4 Read: 700k(2TB/1TB/512GB) Write: 600k(2TB/1TB/512GB) PCIe Gen4 Read: 600k (1TB/512GB/256GB) Write: 500k(1TB/512GB/256GB) not support Gen5
Bandwidth Performance		PCIe Gen4 x 4 (16Gbps)
Power Consumption (Max)		3.0A (10us average)
Active(AVG)		5W
Idle		5mW (L1.2)
Min MTBF		2'000'000
Min Sequential Read		Performance PCIe Gen4 6400MB/s (2TB/1TB/512GB) PCIe Gen4 5000MB/s (1TB/512GB/256GB) not support Gen5
Min Sequential Write		Performance PCIe Gen4 5000MB/s (2TB/1TB/512GB) PCIe Gen4 4000MB/s (1TB/512GB/256GB) not support Gen5
Hardware Encryption		Yes
Disclaimers		

Discrete Graphics Adapter

GPU Name		NNVIDIA RTX PRO 500 (6GB GDDR7)Blackwell Generation Laptop GPU	NNVIDIA RTX PRO 1000 (8GB GDDR7) Blackwell Generation Laptop GPU	
CUDA Processing Cores		2088	2088	
GPU Memory		6GB	8GB	
Memory Bandwidth		288 GB/s	384 GB/s	
Memory Type		GDDR7	GDDR7	
Memory Interface		96-bit	128-bit	
TGP Max Power Consumption		50	50	
Display Port		0	0	
OpenGL		4.6	4.6	
Shader Model		10.4	10.4	
DirectX		12	12	
PCIe Generation		5	5	
Floating-Point Performance		1.1	1.1	
VR Ready		No	No	
Simultaneous Multi-Projection		No	No	
NVIDIA FXAA/TXAA Antialiasing		Yes	Yes	
NVIDIA nView Display Management Technology	Yes	Yes	Yes	
GPU Direct for Video		No	No	
Vulkan Support		Yes	Yes	
NVIDIA Optimus		Yes	Yes	
Disclaimers				

WLAN

Model		WLAN Intel Fillmore Peak 2 WIFI7 BE201	
Connector: Main, Aux/GNSS, GNSS		ANT1:AUX WiFi + BT; ANT2: Main WiFi	
Antenna Diversity		Supported	
MIMO		Supported	
GNSS Bian		N/A	
Radio ON/OFF Control		Supported	
Connector interface		CNVio3	
Operating Temperature (Adapter Shield)		0 °C to +50 °C	
Humidity Non-Operating		50–90% RH @ 25–35 °C	
Operating Systems		Windows 11*, Linux*, ChromeOS*	
Wi-Fi Alliance		802.11a/b/g/n/ac/ax/be, WPA/2/3 Personal and enterprise, WPS2, PMF, WMM,WMM-PS, WFD, Miracast, Passpoint R2, Voice Personal	
IEEE WLAN Standard		802.11 a/b/g/n/ac/ax/be	
Roaming		Support seamless roaming between access points	
Bluetooth*		Bluetooth 5.4	
Authentication		WPA3, WPA2	
Authentication Protocols		EAP-TLS, PEAP, EAP-SIM/AKA	
Encryption		AES-CCMP 128-bit, AES-GCMP 256-bit	
Regulatory		Worldwide, DFS supported	
US Government		FIPS 140-3	
Product Safety		UL, C-UL, CB 62368-1	
Disclaimers			

Battery

Dimension		57Wh: 296.44mm * 64.14mm * 6.75mm	75Wh: 296.44mm * 64.14mm * 8.15mm
Weight		57Wh: 226.14g	75Wh: 272.21g
Type (Chemistry and Cell)		Li-ion Polymer	Li-ion Polymer
Voltage		11.31V	11.61V
Battery Life		N/A	MM25: 14.4H(Best power efficiency), 14.07H(Balanced)
Battery Capacity		Integrated 3-cell 57Wh battery	Integrated 3-cell 75Wh battery
Charging Time		0% to 100% Battery Charging Time (in-operation) 2.11hr Battery Charging Time (off) 1.97 hr	0% to 100% Battery Charging Time (in-operation) 2.35hr Battery Charging Time (off) 2.04 hr
Operating Temperature Range		between 10°C (50°F) and 35°C (95°F)	between 10°C (50°F) and 35°C (95°F)
Warranty		1 Year / 3 Year Available	1 Year / 3 Year Available
Coin Cell Battery (Model)		CR2016	CR2016
Disclaimers			

SECTION IV: BIOS / Certifications / Standards / Environmental

BIOS Specifications

WMI Support		Yes, if it is BIOS Setup change by WMI.
ROM-Based Setup Utility (F1)		Yes
Bootblock Recovery		N/A
Replicated Setup		Yes, it supported with SRSETUP tool.
Boot Control		Yes, it means Boot order change.

Discrete Mode		N/A, no Discrete Mode
Memory Change Alert		N/A
Thermal Alert		N/A
Asset Tag		Yes
System/Emergency ROM Flash Recovery with Video	N/A	
Remote Wakeup/Remote Shutdown		Only support WOL from S5.
Keyboard-less Operation		N/A
Per-port Control		Yes, if it is I/O port enable/disable by BIOS Setup.
Adaptive Cooling		Yes, if it is thermal & fan control.
Security		Yes, BIOS password / Hard disk password / Finger print
Intel(R) AMT (includes ASF 2.0)		Yes. If you select vPro model
Intel(R) TXT		Yes. If you select vPro model
Memory Modes		N/A
UEFI		Unified Extensible Firmware Interface 2.9A

EMC & Safety

EMC		Published, Certified Existing Reports EMC – Australia EMC – Canada EMC – EU/EFTA EMC – Japan EMC – New Zealand EMC – Taiwan EMC – Russia EMC – South Korea EMC – Kazakhstan EMC – USA/Territories EMC – Belarus Not Applicable / Not Required EMC – Israel EMC – Moldova EMC – Serbia EMC – Turkey
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		EMC – Uzbekistan EMC – Vietnam
Safety		To access the latest User Guide and Safety and Warranty Guide, go to: https://support.lenovo.com Low Halogen Declaration of Conformance TNOT-2017-0040 Section 9 – Low Halogen Scorecard Izod Test – EPEAT Compliant Homologation PCRB Compliant In the following countries: Albania, Algeria, Andorra, Angola, Antigua and Barbuda, Argentina, Armenia, Aruba, Australia, Azerbaijan, Bahamas, Bahrain, Bangladesh, Barbados, Belarus, Belize, Benin, Bermuda, Bolivia, Botswana, Burkina Faso, Burundi, Cambodia, Cameroon, Canada, Cape Verde, Cayman Islands, Central African Republic, Chad, China, Colombia, Comoros, Congo, Costa Rica, Djibouti, Dominican Republic, Egypt, El Salvador, Eritrea, Ethiopia, EU/EFTA, Fiji, Gabon, Gambia, Georgia, Ghana, Grenada, Guatemala, Guinea, Haiti, Honduras, Hong Kong, India, Indonesia, Israel, Jamaica, Japan, Jordan, Kazakhstan, Kenya, Kuwait, Laos, Lebanon, Liberia, Macau, Madagascar, Malawi, Malaysia, Mali, Mauritania, Mauritius, Mexico, Moldova, Mongolia, Morocco, Mozambique, Namibia, Nepal, New Zealand, Nicaragua, Niger, Nigeria, Oman, Pakistan, Panama, Papua New Guinea, Paraguay, Peru, Philippines, Qatar, Russia, Saudi Arabia, Senegal, Serbia, Seychelles, Sierra Leone, Singapore, South Africa, South Korea, Sri Lanka, Swaziland, Taiwan, Tajikistan, Tanzania, Thailand, Togo, Tunisia, Turkey, Turkmenistan, Uganda, Ukraine, United Arab Emirates, Uruguay, USA/Territories, Uzbekistan, Venezuela, Vietnam, Zambia, Zimbabwe, Brazil – Inmetro 170 Govt Bids, Guinea-Bissau, Lesotho

Environmentals

Energy Star		ENERGY STAR® Version 9.0 For more information about ENERGY STAR, go to: https://www.energystar.gov	
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EPEAT		EPEAT Declaration of Conformance For Machine Types: 21QT, 21QU	
IT ECO declaration			The latest environmental information about Lenovo products is available at: https://www.lenovo.com/ecodeclaration
Hazardous Substances			The latest environmental information about Lenovo products is available at: https://www.lenovo.com/ecodeclaration European Union RoHS This Lenovo product, with included parts (cables, cords, and so on) meets the requirements of Directive 2011/65/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("RoHS recast" or "RoHS 2"). For more information about Lenovo worldwide compliance on RoHS, go to: https://www.lenovo.com/rohs-communication

Manageability

Industry Standard Specifications		This product meets the following industry standard specifications for manageability functionality: Intel LAN with AMT
Remote Manageability Software Solutions		Lenovo ThinkManagement Console Microsoft System Center Configuration Manager LANDesk Management Suite for ThinkVantage Technologies (www.landesk.com/lenovo)
System Software Manager		Lenovo ThinkPad supports software management tools from the Lenovo Vantage System Update suite: System Update Update Retriever
Service, Support, and Warranty		On-site Warranty and Service: Three-years, limited warranty and service offering delivers on-site, next business-day service for parts and labor and includes free telephone support 8am to 5pm. Global coverage ensures that any product purchased in one country and transferred to another, non-restricted country

will remain fully covered under the original warranty and service offering.

Environmentals

Energy Star		ENERGY STAR® 9.0	
EPEAT		EPEAT® Gold	
RoHS Compliant		RoHS Compliant	
TCO		TCO 10.0	
Sustainability		90% PCC recycled plastic: Speaker enclosure 90% recycled plastic: 57Whr/75 Whr Battery 90% PCC recycled plastic: 100W PSU 90% recycled/sustainable packaging Low-temperature solder	
Disclaimers		Product packaging shall contain, on average, a minimum total percentage of 90% by weight of any combination of the following materials: Recycled content, biobased plastic, non-wood biobased fiber material, and/or sustainably forested material.	
Materials Used		50% Recycled Aluminum A Cover 90% Recycled Magnesium Aluminum C cover middle frame 50% Recycled Aluminum D Cover 85% PCC Plastic in Key Caps, Backlit 90% PCC Plastic Speaker Enclosure 97% PCC Plastic Battery Pack Enclosure 90% PCC Plastic Slim 100W AC Adapter Low Temperature Solder (memory, SSD, fingerprint reader module) Plastic free packaging with 90% recycled and/or FSC certified content (standard)	
TCO Certification		10	
Disclaimers		1. EPEAT registered where applicable. EPEAT registration varies by country. See www.epeat.net for registration status by country. 2. Product packaging shall contain, on average, a minimum total percentage of 90% by weight of any combination of the following materials: Recycled content, biobased plastic,	

		non-wood biobased fiber material, and/or sustainably forested material
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